

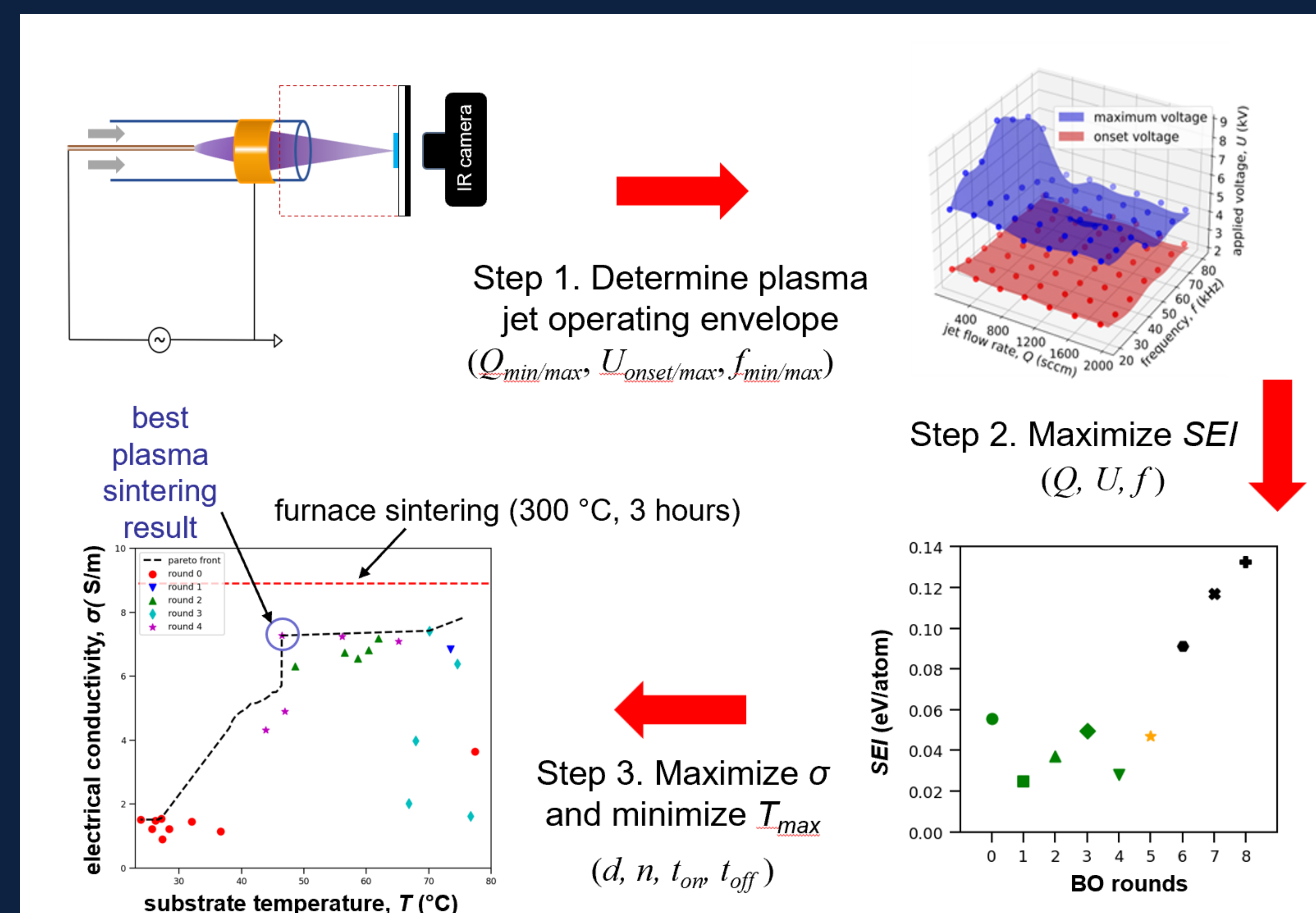
Accelerating Low-temperature Processing of Printed Nanoinks Using Machine Learning and Bayesian Optimization of Non-thermal Plasma Jet Sintering

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Motivation

- Rapid processing of emerging nanomaterials on flexible and thermosensitive substrates for applications in wearable electronics and *in situ* sensors
- Non-thermal plasma jets enable simple and low-temperature sintering of printed thin films on delicate substrates^{1,2}
- Machine learning Bayesian optimization (BO) approaches optimize multi-dimensional experimental problems in a low-cost and efficient way³

Optimization Workflow & Results



Objectives:

- maximize electrical conductivity (σ) of ITO thin films
- minimize the peak substrate temperature (T_{max})

Decision variables:

- $Q, U, f, d, n, t_{on}, t_{off}$
- BO increases SEI by 2.4×
- Pareto front indicates the best trade-off between σ and T_{max}

Summary

- Bayesian optimization method optimized 7-dimensional variable space to maximize the electrical conductivity of ITO films and control the substrate temperature under a relatively low value
- Non-thermal plasma jet sintering of ITO produced a conductivity of 7.6 S m^{-1} with a substrate temperature below 47 °C in 1 hour
- Achieved 81.4% of furnace sintering with a temperature 250 °C lower and 3× faster

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